



Meets MIL-STD-202 Method 109 Condition F3 <u>Temperature Cycle</u>
T50R0-60-50E

T50R0-60-50E Features:

- TCE Matched, All Brazed Construction
- RoHS Compliant
- Customer Defined Testing Available
- Enhanced Mechanical Strength
- Covered Resistor Element
- ±5% Resistor Tolerance

T50R0-60-50E Parameters:

Operating Frequency: DC - 6GHz
Rated Power: 60W*

Return Loss (Typical)**: 17dB or Better Impedance: $50\Omega \pm 5\%$ ***

Resistor Construction: Thick Film on BeO Attached with AuGe Braze

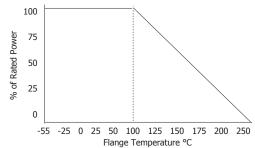
Flange Construction: Copper Tungsten

Lead Construction: Copper Attached with AuGe Braze

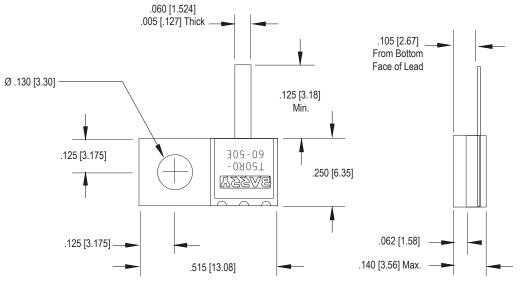
Operating Temperature: -55 to +150°C

The Parties of the Pa

T50R0-60-50E Power Derating Curve



T50R0-60-50E Dimensions:





Dimensions in inches [mm]
Tolerance is ± 0.010 [0.254]
unless otherwise stated

- * Rating based on ≤100°C constant flange temperature
 ** In a matched, continious 50Ω system with proper
- workmanship

 *** Other values and tolerances available. Contact factory.

Ordering Information:



Barry Industries reserves the right to change part number and/or process without notification.





| ORIG. | REV. | No. | |
|---------------|---------------|-----|--|
| DEC 7 2003 | NOV 5 2014 | С | |
| PAGE 1 OF 2 | | | |





60W BeO Flanged TerminationMeets MIL-STD-202 Method 109 Condition F3 <u>Temperature Cycle</u> T50R0-60-50E

T50R0-60-50E Reliability Data:

| Parameter: | Test Condition: | Results: |
|---|---|---|
| Short Time Overload | Apply 1.1x Rated Power for 5 Seconds. | ≤ 2.0% Resistance Shift |
| Rated Load Life | Apply Full Power at 100°C ±2°C 90 Minutes on/ 30 Minutes off. Repeat for 1000 hours | ≤ 2.0% Resistance Shift |
| Moisture Resistance | MIL-PRF-55342 para.4.8.9 95% RH, 25°C - 65°C | ≤ 2.0% Resistance Shift |
| Resistance to Soldering Heat (Lead) | MIL-STD-202 Method 210 Test Condition "A" | ≤ 2.0% Resistance Shift |
| Resistance to Soldering Heat (Assembly) | MIL-STD-202 Method 210 Test Condition "J" | ≤ 2.0% Resistance Shift |
| Terminal Strength | MIL-STD-202 Method 211 Test Condition "A" 3lbs. Test Condition "B" 5 bends | No Significant Abnormality (Visual) |
| Solderability (Lead only) | MIL-STD-202 Method 208 Test C | >95% Covered |
| High Temperature Storage | 125°C ±2°C for 500 Hours | 1.) ≤ 2.0% Resistance Shift2.) No Significant Abnormality (Visual) |
| Thermal Shock | -65°C to +150°C Each Cycle 30 Minutes for 500 Hours | 1.) ≤ 2.0% Resistance Shift2.) No Significant Abnormality (Visual) |

For further detail on the advantages of using TCE Matched Copper-Tungsten flange mount devices from Barry Industries please refer to the Application Note 'Finite Element Analysis of a High Power Resistor'. This document can be found on the Barry Industries website: www.barryind.com.

Barry Industries reserves the right to change part number and/or process without notification.





| ORIG. | REV. | No. | |
|---------------|---------------|-----|--|
| NOV 7 2003 | NOV 5 2014 | С | |
| PAGE 2 OF 2 | | | |